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A type AM series 2	X type	Page No. Contents
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ŀ	A type AM series X type	1								
Notice matter										
 Law and regulation which 	n are applied									
 This product complies with the RoHS Directive (Restriction of the use of certain Hazardous Substances in electrical and electronic equipment (DIRECTIVE 2002/95/EC). 										
 No Ozone Depleting Chemicals(ODC's), controlled under the Montreal Protocol Agreement, are used in producing this product. 										
· We do not PBBs or PBI	DEs as brominated flame retardants.									
 All the materials that are used for this product are registered as "Known Chemicals" in the Japanese act "Law Concerning the Examination and Regulation of Manufacture, etc. of Chemical Substances". 										
	n followed export related regulations, such as foreign exchange a ccasion of export of this product .Thank you for your consideratio									
 Limitation of a use 										
home appliances, comp and industrial robots. High reliability and safe to a human life or prope	 This capacitor is designed to be used for electronics circuits such as audio/visual equipment, home appliances, computers and other office equipment, optical equipment, measuring equipment and industrial robots. High reliability and safety are required [be / a possibility that incorrect operation of this product may do harm to a human life or property] more. When use is considered by the use, the delivery specifications which suited the use separately need to be exchanged. 									
 Unless otherwise specif 	ied, the product shall conform to JIS 5101-4-1									
 Country of origin : JAPA 	N, MALAYSIA									
 Manufacturing factory : 	Panasonic Electronic Devices Yamaguchi Co.,Ltd. 1285, Aza-Sakutaguchi, Oaza-Asada,Yamaguchi City, Yamag 753-8536 Japan	guchi								
	Panasonic Electronic Devices Malaysia Sdn.Bhd. No.1 Jalan Jemuju 16/13,40200 Shah Alam,Selangor Darul B	Ehsan, MALAYSIA								

			Enę	gineeriı	ng Draf	ť				CE	E-AAMX-CEM-1
			2								
		ors for use in e r	electroni	ic equipr	nent, Alı	uminum e	electroly	ic capac	itors witl	n non-sol	id electrolyte.
	<u>E C</u> 2-1		A 2-4	<u>M (</u> 4	<u>2-5</u>	<u>X</u> 2-4	<u> </u>				
2-1	Aluminu	ım Electrolytic	Capaci	tor							
2-2	Type : F	Radial lead typ	e(JIS:	04 type)						
2-3	Rated \	/oltage Code									
	Voltage C		0J	1A	1C	1E	1V	1H	1J	2A	
I	Rated Vo	ktage (V.DC)	6.3	10	16	25	35	50	63	100	
		C " 2	lenotes R" deno actual nu	the num tes the c imber wi	ber of ze decimal ith "R".	ual value eros. point and essed as	l all figur	es are th			
		e	ex. 0.1	$\mu F \rightarrow 0I$	R1 , ´	$10\mu F \rightarrow 7$	100 ,	1000µF	→ 102		
2-6	Suffix Co	ode for Appear	ance :	Specia	al Code	for Appe	arance				
	Blank	Standard Lor									
_	<u> </u>	Snap-in lead		nitch)							
-	B	Lead taping (
	tem 9 for	snap-in lead,									
		or lead taping nd Item 12 for			oification						
I			ieau iaj	ping spe	cincation	15.					

	С	CE-AAMX-CEM-1								
	A type AM series X type									
Parts lists	<u>.</u>									
	Part No.	W.V. [V.DC]	Cap. [µF] (120Hz)	of loss angle max. (120Hz)	Current [µA] max. (After	Rated Ripple Current [mA rms] max. (120Hz)	D	im. [mm]		
			(20℃)	(20℃)	2 min.)	(85℃)	φD	L	φd	
	ECA0JAM221X	6.3	220	0.28	13.8	240	5	11	0.5	
	ECA0JAM471X	6.3	470	0.28	29.6	380	6.3	11.2	0.5	
	ECA0JAM102X	6.3	1000	0.28	63.0	580	8	11.5	0.6	
	ECA0JAM222X	6.3	2200	0.30	138.6	890	10	16	0.6	
	ECA0JAM332X	6.3	3300	0.32	207.9	1020	10	20	0.6	
	ECA0JAM472X	6.3	4700	0.34	296.1	1170	12.5	20	0.6	
	ECA0JAM682X	6.3	6800	0.38	428.4	1270	12.5	25	0.6	
	ECA0JAM103X	6.3	10000	0.46	630.0	1450	16	25	0.8	
	ECA0JAM153X	6.3	15000	0.56	945.0	1700	16	31.5	0.8	
	ECA0JAM223X	6.3	22000	0.70	1386.0	1900	18	35.5	0.8	
	ECA1AAM331X	10	330	0.24	33.0	330	6.3	11.2	0.5	
	ECA1AAM102X	10	1000	0.24	100.0	630	10	12.5	0.6	
	ECA1AAM222X	10	2200	0.26	220.0	920	10	20	0.6	
	ECA1AAM332X	10	3300	0.28	330.0	1090	12.5	20	0.6	
	ECA1AAM472X	10	4700	0.30	470.0	1200	12.5	25	0.6	
	ECA1AAM682X	10	6800	0.34	680.0	1400	16	25	0.8	
	ECA1AAM103X	10	10000	0.42	1000.0	1600	16	31.5	0.8	
	ECA1AAM153X	10	15000	0.52	1500.0	1850	18	35.5	0.8	
	ECA1CAM100X	16	10	0.20	3.0	30	5	11	0.5	
	ECA1CAM220X	16	22	0.20	3.5	75	5	11	0.5	
	ECA1CAM330X	16	33	0.20	5.2	110	5	11	0.5	
	ECA1CAM470X	16	47	0.20	7.5	130	5	11	0.5	
	ECA1CAM101X	16	100	0.20	16.0	180	5	11	0.5	
	ECA1CAM221X	16	220	0.20	35.2	280	6.3	11.2	0.5	
	ECA1CAM471X	16	470	0.20	75.2	440	8	11.5	0.6	
	ECA1CAM102X	16	1000	0.20	160.0	680	10	16	0.6	
	ECA1CAM222X	16	2200	0.22	352.0	1000	12.5	20	0.6	
	ECA1CAM332X	16	3300	0.24	528.0	1200	12.5	25	0.6	
	ECA1CAM472X	16	4700	0.26	752.0	1360	16	25	0.8	
	ECA1CAM682X	16	6800	0.30	1088.0	1600	16	31.5	0.8	
	ECA1CAM103X	16	10000	0.38	1600.0	1800	18	35.5	0.8	

	Engineering Draft											
	A type AM series X type											
Parts lists	S											
				Tangent	Leakage	Rated Ripple						
	Part No.	W.V.	Cap.	of loss	Current	Current	Dim.[mm]					
		[V.DC]	[µF]	angle	[µA]	[m Arm s]						
				max.	max.	max.						
			(120Hz)	(120Hz)	(After	(120Hz)						
			(20°C)	(20°C)	2 m in.)	(85℃)	φD	L	φd			
	ECA1EAM101X	25	100	0.16	25.0	180	6.3	11.2	0.5			
	ECA1EAM331X	25	330	0.16	82.5	390	8	11.5	0.6			
	ECA1EAM471X	25	470	0.16	117.5	480	10	12.5	0.6			
	ECA1EAM102X	25	1000	0.16	250.0	850	10	20	0.6			
	ECA1EAM222X	25	2200	0.18	550.0	1200	12.5	25	0.6			
	ECA1EAM332X	25	3300	0.20	825.0	1300	16	25	0.8			

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1700.0

16.4

35.0

77.0

115.5

1<u>64.5</u>

350.0

770.0

1155.0

1645.0

3.0

3.0

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3.0

5.0

11.0

16.5

23.5

50.0

110.0

165.0

235.0

500.0

1100.0

1650.0

1500

1750

130

210

350

440

550

900

1250

1400

1600

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400

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650

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1300

1500

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31.5

35.5

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4700

6800

47

100

220

330

470

1000

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3300

4700

0.1

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0.47

1.0

2.2

3.3

4.7

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330

470

1000

2200

3300

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ECA1EAM472X

ECA1EAM682X

ECA1VAM470X

ECA1VAM101X

ECA1VAM221X

ECA1VAM331X

ECA1VAM471X

ECA1VAM102X

ECA1VAM222X

ECA1VAM332X

ECA1VAM472X

ECA1HAM0R1X

ECA1HAMR22X

ECA1HAMR33X

ECA1HAMR47X

ECA1HAM010X

ECA1HAM2R2X

ECA1HAM3R3X

ECA1HAM4R7X

ECA1HAM100X

ECA1HAM220X

ECA1HAM330X

ECA1HAM470X

ECA1HAM101X

ECA1HAM221X

ECA1HAM331X

ECA1HAM471X

ECA1HAM102X

ECA1HAM222X

ECA1HAM332X

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Parts lists

Parts lists										
				Tangent	Leakage	Rated Ripple				
	Part No.	W.V.	Cap.	of loss	Current	Current	Di	m.[mm]	
		[V.DC]	[µF]	angle	[µA]	[mArms]				
				max.	max.	max.				
			(120Hz)	(120Hz)	(After	(120Hz)				
			(20°C)	(20℃)	2 min.)	(85℃)	φD	L	φd	
	ECA1JAM100X	63	10	0.11	6.3	70	5	11	0.5	
	ECA1JAM220X	63	22	0.11	13.8	105	5	11	0.5	
	ECA1JAM330X	63	33	0.11	20.7	130	6.3	11.2	0.5	
	ECA1JAM470X	63	47	0.11	29.6	160	6.3	11.2	0.5	
	ECA1JAM101X	63	100	0.11	63.0	270	8	11.5	0.6	
	ECA1JAM221X	63	220	0.11	138.6	450	10	16	0.6	
	ECA1JAM331X	63	330	0.11	207.9	550	10	20	0.6	
	ECA1JAM471X	63	470	0.11	296.1	750	12.5	20	0.6	
	ECA1JAM102X	63	1000	0.11	630.0	1100	16	25	0.8	
	ECA1JAM222X	63	2200	0.13	1386.0	1400	18	35.5	0.8	
	ECA2AAMR47X	100	0.47	0.10	3.0	10	5	11	0.5	
	ECA2AAM010X	100	1.0	0.10	3.0	20	5	11	0.5	
	ECA2AAM2R2X	100	2.2	0.10	3.0	30	5	11	0.5	
	ECA2AAM3R3X	100	3.3	0.10	3.3	40	5	11	0.5	
	ECA2AAM4R7X	100	4.7	0.10	4.7	50	5	11	0.5	
	ECA2AAM100X	100	10	0.10	10.0	70	5	11	0.5	
	ECA2AAM220X	100	22	0.10	22.0	115	6.3	11.2	0.5	
	ECA2AAM330X	100	33	0.10	33.0	145	8	11.5	0.6	
	ECA2AAM470X	100	47	0.10	47.0	180	8	11.5	0.6	
	ECA2AAM101X	100	100	0.10	100.0	350	10	16	0.6	
	ECA2AAM221X	100	220	0.10	220.0	550	12.5	20	0.6	
	ECA2AAM331X	100	330	0.10	330.0	700	12.5	25	0.6	
	ECA2AAM471X	100	470	0.10	470.0	900	16	25	0.8	
	ECA2AAM102X	100	1000	0.10	1000.0	1300	18	35.5	0.8	
-							-			

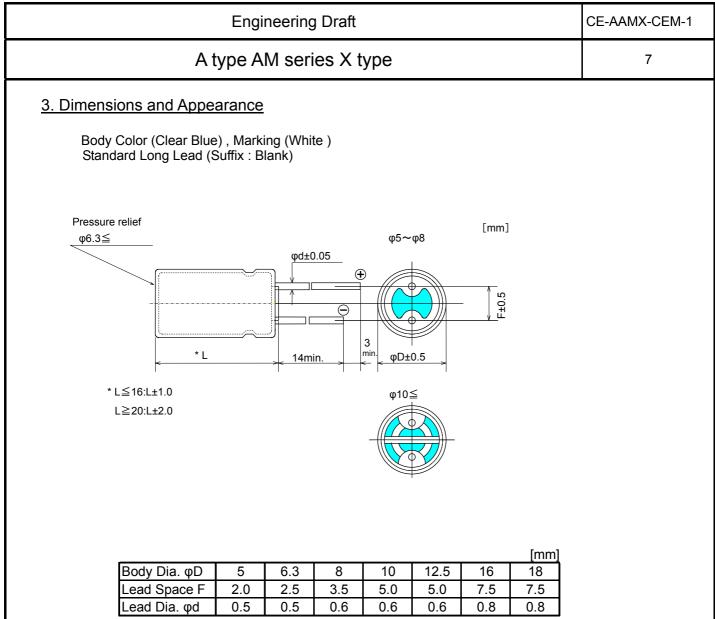
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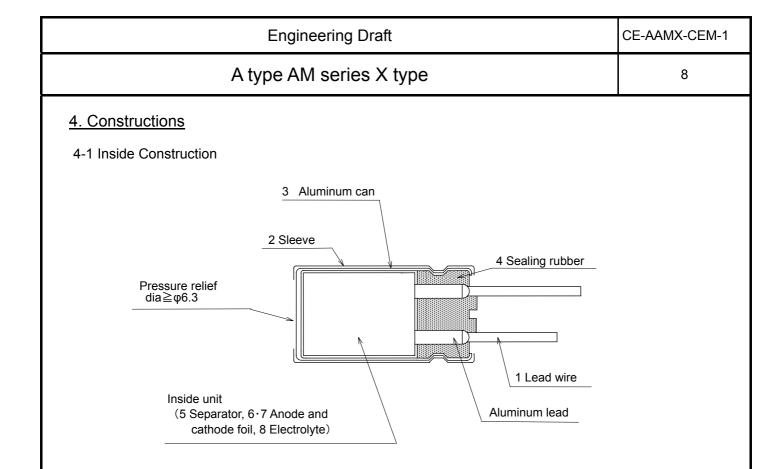
Capacitance and Can Size Table

							-	φD×L [mm]
V.DC Cap (µF)	6.3	10	16	25	35	50	63	100
0.1						5×11		
0.22						5×11		
0.33						5×11		
0.47						5×11	\rightarrow	5×11
1.0						5×11	\rightarrow	5×11
2.2						5×11	\rightarrow	5×11
3.3						5×11	\rightarrow	5×11
4.7						5×11	\rightarrow	5×11
10			5×11	\rightarrow	\rightarrow	5×11	5×11	5×11
22			5×11	\rightarrow	\rightarrow	5×11	5×11	6.3×11.2
33			5×11	\rightarrow	\rightarrow	5×11	6.3×11.2	8×11.5
47			5×11	\rightarrow	5×11	6.3×11.2	6.3×11.2	8×11.5
100			5×11	6.3×11.2	6.3×11.2	8×11.5	8×11.5	10×16
220	5×11	\rightarrow	6.3×11.2	\rightarrow	8×11.5	10×12.5	10×16	12.5×20
330	\rightarrow	6.3×11.2	\rightarrow	8×11.5	10×12.5	10×16	10×20	12.5×25
470	6.3×11.2	\rightarrow	8×11.5	10×12.5	10×16	10×20	12.5×20	16×25
1000	8×11.5	10×12.5	10×16	10×20	12.5×20	12.5×25	16×25	18×35.5
2200	10×16	10×20	12.5×20	12.5×25	16×25	16×31.5	18×35.5	
3300	10×20	12.5×20	12.5×25	16×25	16×31.5	18×35.5		
4700	12.5×20	12.5×25	16×25	16×31.5	18×35.5			
6800	12.5×25	16×25	16×31.5	18×35.5				
10000	16×25	16×31.5	18×35.5					
15000	16×31.5	18×35.5						
22000	18×35.5							

Please refer to a high-ranking voltage for " $\!\rightarrow$ "



Please refer to L dimension on the parts number lists table.



4-2 Construction Parts

	Parts	Materials		Parts		Materials
1	Lead Wire	Solid tinned copper weld	5	Separator		Manila hemp
		steel wire				
2	Sleeve	Thermoplastic Resin	6	Anode Foil		High purity
						Aluminum foil
3	Aluminum Can	Aluminum	7	Cathode Fo	bil	Aluminum foil
4	Sealing Rubber	Synthetic rubber	8	Electrolyte	Main Solvent	Ethlene glycol
		(EPT/IIR)			Main Solute	Ammonium salt

5. Marking

Markings indicated on the products :

- a) Rated Voltage.
- b) Capacitance
- c) Negative Polarity
- d) Manufacturer's Trademark
- e) Upper Category Temperature
- f) Series Code
- g) Lot No. (It indicates to Lot No. System)

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Radial lead type Lot No. System	9								
 JAPAN PRODUCTS Lot number is indicated on a sleeve in following manner. eg. For 04 type, expressed in 3 figures, 4 figures, or 5 figures. 	1								
(a) (b) (c) (a)sequential alphabet for each lot (b)month (1 to 9 and O for October, N for November, D for Decem (c)sequential alphabet for	nber)								
(a) (b) (c) (d) As for the display contents of 4 figures, there are 2 kin (1) (a) last number of year (b) month (1 to 9 and O for October, N for November, D (c) week (1 to 5 and A to E) (d) line code in alphabet (A to Z)									
 (d) line code in alphabet (A to Z) (2) (a) last number of year (b) month (1 to 9 and O for October, N for November, D for December) (c) line code in alphabet (A to Z) (d) production date 									
(a) (b) (a) last 2 digit of year (b) numerical indication of week (ninth week of 1992=09) (a) last number of year (b) month (1 to 9 and O for October, N for November, D (c) week (1 to 5 and A to E)									
(d) line code production year production month production week production									
1:20011:January7:JulyA,1: first weekA=1 date1=2:20022:February8:AugustB,2:second weekB=22=3:20033:March9:SeptemberC,3: third weekC=33=	27 date 28 29 30 31								

* Lot number can be written in both horizontal and vertical directions. * Manufacturing country for certain products may not be indicated.

 $\,\,\%\,$ Letters and marks are also used to distinguish different lines, machines and shifts operation.

	CI	E-AAMX-CEM-1								
	Radial	lead type Lot	No. System			10				
•MALAYSIA PRODUC Lot number is indica eg. For 04 type, e	ated on a sleev	-								
(a) (b) (c) (c)										
	(a) last number of year(b) month (1 to 9 and O for October, N for November, D for December)(c) line code in alphabet (A to Z)									
(a)	(a) (b) (b) (a) (a) last number of year and line code in alphabet (A to Z) (b) month (1 to 9 and O for October, N for November, D for December) and production date									
(a) (b) (c) ((b) mont	(Greece number	October, N for Nove)	mber, D for	December)				
production year	produ	tion month	l product	ion wook	produ	unitian data				
production year 1:2001 2:2002 3:2003 4:2004 \sim Indicating with the last digit or the last 2 digits of a year.	produc 1:January 2:February 3:March 4:April 5:May 6:June	ction month 7:July 8:August 9:September O:October N:November D:December	I : first week	ion week A,1: first week B,2:second week C,3: third week D,4: forth week E,5: fifth week	1:1date	U:30date V:31date				

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6. Standard Ratings

No.	Item				R	atings				
1	Category Temperature Range				-40 °C	\sim +85	5℃			
2	Rated Voltage Range	6.3 V.DC $\sim~$ 100 V.DC								
3	Capacitance Range	$0.1 \ \mu F \sim \ 22000 \ \mu F$ (120Hz 20°C)								
4	Capacitance Tolerance				± 20°	%			(120H	z 20℃)
5	Surge Voltage	R.V.	6.3	10	16	25	35	50	63	100
	(V.DC)	S.V.	8	13	20	32	44	63	79	125
6	Rated Ripple Current	Parts Lists and Table3								

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7. Performance Characteristics

No	Item	Performance Characteristics		Test	
1	Leakage Current	≦ I = 0. 01CV or 3μA, whichever is greater. I : Leakage current C : Capacitance V : Rated voltage	Applied Voltage: Rated voltageMeasuring: After 2 minutes		
2	Capacitance	Within the specified capacitance tolerance.	Measuring Frequency: 120 Hz \pm 20%Measuring Circuit: Equivalent series ciMeasuring Voltage: +1. 5V. DC \sim +2 V($\leq 0.5V$ for AC.)		series circuit \sim +2 V. DC
	Tangent of Loss Angle (tanδ)	Less than the table 1 value of item 8. Added 0. 02 per 1000μF for items with over 1000μF.	$\begin{array}{llllllllllllllllllllllllllllllllllll$		% series circuit \sim +2 V. DC
4	Characteristics at High and Low Temperature	Step 2Impedance Ratio :Ratio for the value in step 1 shall beless than the value from table 2 initem 8.Step 4Leakage Current : \leq 500% of the value of item 7. 1.Capacitance Change :Within ±25% of the value in step 1Tangent of Loss Angle (tan δ): \leq the value of item 7. 3.	1 2 3 4 5 Impe of 12 * C te ca	20± 2 -25±3, -40±3 20± 2 85± 2 20± 2 dance should be measured at the 0 Hz±10%. apacitors should be stored at eac mperature until measured imped apacitance is stabilized.	h
5	Surge	Leakage Current : ≦ the value of item 7.1. Capacitance Change : Within ±15% of the initially measured value. Tangent of Loss Angle (tanδ): ≦ the value of item 7. 3. Appearance : No significant change can be observed.	Test Temperature : 15° C ~ 35° C Series Protective Resistance : $R = \frac{100 \pm 50}{C}$ $\begin{pmatrix} R = Series \text{ protective resistance } (k\Omega) \\ C = Capacitance (\mu F) \\ Test Voltage : Surge voltage item 6.5 \\ Applied Voltage : 1000 cycles of 30s\pm5s \\ "ON" and 5 min. 30 s "OFF$		

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A type AM series X type

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No	Item	Performance Characteristics	Tes	st
6	Robustness of			
	Terminations		Diameter [mm]	Pull Strength
	Tensile		φ0.5	5 N
			$ m \phi 0.6 \sim m \phi 0.8$	10 N
		There is no damage or breakage after	Applied above steady pull a	axially for a 10s±1s
	Bending	test.		
			Diameter [mm]	Static Load
			φ0.5	2.5 N
			$\phi 0.6 \sim \phi 0.8$	5 N
			At first, a capacitor is place	
			with the weight specified al	
			one of leads. Then the cap	
			rotated 90°to horizontal po	
			subsequently returned to v	
			The above bending proced	
			An additional bending is do	one in the opposite
			direction.	
7	Vibration	Capacitance :	Frequency : 10 Hz \sim	
		Measured value is to be stabilized	(1 minute per	r cycle.)
		during test. (Measured several times	Total Amplitude : 1.5 mm	<i>a</i>
		within 30 min.	Direction and Duration of V	
		before completion of test)	It is done in the X, Y, Z	
		Appearance :	hours each, with a total	of 6 hours.
		No significant change can be	Mounting Method :	
		observed.	The capacitor shall be f	
		Capacitance Change :	at the point of 4 mm fro	
		Within ±5% of the initially measured value.	capacitor body. The ca	•
		measureu value.	greater than 12. 5 mm of must be fixed in place v	÷
Q	Solderability	More than 3/4 of the terminal surface		A, H60S, or H63A (JIS Z3282)
0	Soluerability	shall be covered with new solder.	Solder Temperature : 235°	
		Shall be covered with new solder.	Immersing Time : 2s±0	
			-	nm \sim 2. 0mm from the root.
			- · ·	ox. 25% rosin (JIS K5902)
				HANOL (JIS K8101)
9	Resistance to	Leakage Current :		A, H60S, or H63A (JIS Z3282)
Ĩ	Soldering Heat	÷	Solder Temperature : 260%	
	e e la e	Capacitance Change :	Immersing Time : 10s±	
		Within ±10% of the initially		nm \sim 2. 0mm from the root.
		measured value.		
		Tangent of Loss Angle (tanδ):		
		\leq the value of item 7. 3.		
		Appearance :		
		No significant change can be		
		observed.		

Engineering Draft

CE-AAMX-CEM-1

A type AM series X type

No	Item	Performance Characteristics	Test	
10	Solvent Resistance of	There shall be no damage and legible marking. Marking can be easily	Class of Reagent : Isoprop Test Temperature : 20°C ~	yl Alcohol ∽ 25℃
	Marking	comprehended.	Immersing Time : 30s±5s	
11	Pressure Relief (More than φ6. 3 diameter products)	Pressure relief shall be operated without any hazardous expulsion or emission of flame. No emission of gas after 30 minutes of the voltage application also meets the specification.	AC Current Method	er
			Applied Voltage :	
			AC voltage equals to rated V	VVx07or
			250 V (rms), whichever is sr	
			Capacitance	DC Resistance
			(μF)	(Ω)
			<u>≦</u> 1	1000±100
			 >1 ≦10	100±10
			>10 ≦100	10±1
			>100 ≦1000	1±0.1
			>1000 ≦10000	0.1±0.01
			>10000	*
			* When capacitance is over 100 of series resistance equals to	
			tested capacitor's impedance	
			Reverse Voltage Method	
			+ A D.C. Power supply -	Cx //// +
			(À):D.C. ammeter Cx :Teste	d capacitor
			Nominal Diameter [mm]	DC Current (A)
			≦22.4	1 (const)
			>22.4	10 (const)

Engineering Draft

CE-AAMX-CEM-1

A type AM series X type

ltem	Performance Characteristics	Test
2 Damp Heat (Steady state)	Leakage Current : ≦ the value of item 7.1. Capacitance Change : Within ±20% of the initially measured value. Tangent of Loss Angle (tanδ): ≦ 120% the value of item 7. 3. Appearance : No significant change can be abaaaved	Test Temperature $: 40^{\circ}C \pm 2^{\circ}C$ Relative Humidity $: 90\% \sim 95\%$ Test Duration $: 240$ hours ± 8 hoursAfter subjected to the test, capacitors shallbe left for 2 hours at room temperature androom humidity prior to the measurement.
3 Endurance	observed. Leakage Current : ≦ the value of item 7.1. Capacitance Change : Within ±20% of the initially measured value. Tangent of Loss Angle (tanδ): ≦ 150% of the value of item 7.3. Appearance : No significant change can be observed.	Test Temperature : 85°C±2°C Test Duration : 2000 ⁺⁷² ₀ hours Applied Voltage : Rated voltage After subjected to the test, capacitors shall be left at room temperature and room humidity for 2 hours prior to the measurement.
4 Shelf Life	Leakage Current : ≦ the value of item 7.1. Capacitance Change :	Test Temperature: $85^{\circ}C \pm 2^{\circ}C$ Test Duration: 1000^{+48}_{0} hoursAfter subjected to the test with no voltage applied, capacitors shall undergo voltage treatment and be left for 2 hours at room temperature and humidity prior to the measurement.
* Voltage treatm		to the capacitors, which are connected to series protecti tes as a posttest treatment (performing discharge).

Engineering Draft	CE-AAMX-CEM-1
A type AM series X type	16

8. Other Characteristics

	V.DC	6.3	10	16	25	35	50	63	100	
	D.F.	0.28	0.24	0.20	0.16	0.14	0.12	0.11	0.10	
Added 0, 02 per 1000uE for items with over 1000uE items										

Added 0. 02 per 1000 μF for items with over 1000 μF items.

■ Table 2.Characteristics at low temperature Impedance ratio (at 120 Hz)

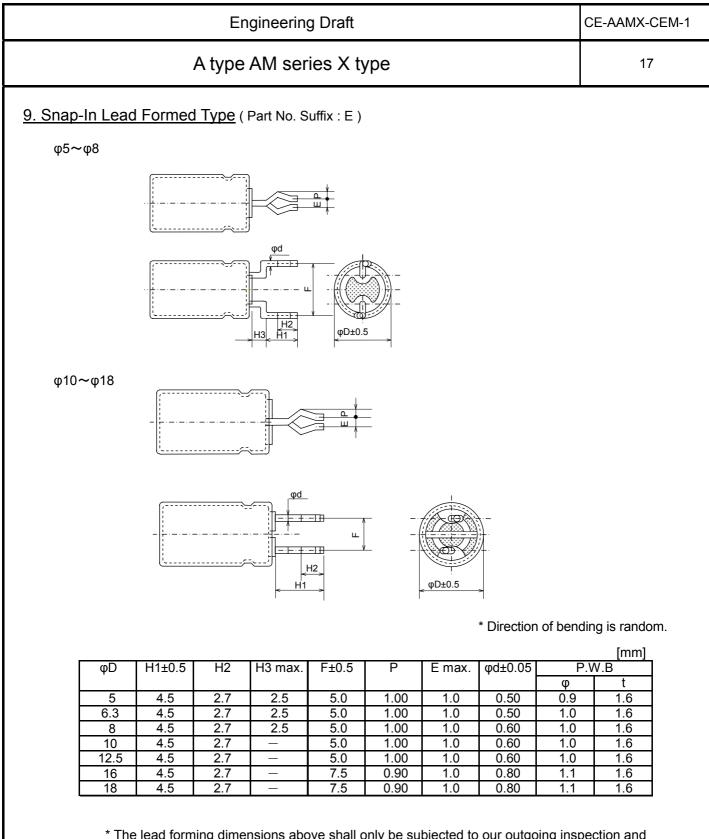
			- · ·			r	1	
V.DC	6.3	10	16	25	35	50	63	100
Z(-25℃)/Z(20℃)	5	4	3	2	2	2	2	2
Z(-40°C)/Z(20°C)	12	10	8	5	4	3	3	3

-25°C : Added 0.5 per 1000 μF for items with over 1000 μF items.

-40°C : Added 1.0 per 1000 μF for items with over 1000 μF items.

■ Table 3.Frequency Correction Factor of Rated Ripple Current

	Frequency (Hz)					
	50,60	120	1k	10k \sim		
Coefficient	0.7	1	1.3	1.7		



* The lead forming dimensions above shall only be subjected to our outgoing inspection and not to the customer's incoming inspection.

Due to the application of mechanical stress during transportation, actual dimensions might not meet the specification.

	E	ngineering Draft		CE-AAMX-CEM-
A type AM series X type				
1) Applicable Range	s applied to pr gle tape.	<u>neter φ5 ~φ6. 3)</u> The Su roducts, which are Aluminur	-	-
φ5			φ6.3	
AP P2 F P2 F P1 F P1 F P0				$\begin{array}{c c} & \phi D \\ \hline P2 & P \\ \hline \hline \\ \hline \\ P1 & F \\ \hline \\ \hline \\ P0 & \phi d \\ \hline \\$
	Symbol	Dimensions	Tolerance	[mm] Remarks
Itom				Remarks
Item Body diameter		5 63	+115	
Body diameter	φD	5 6.3 11 0 ~ 11 2	±0.5	
Body diameter Body length	φD L	11.0 ~ 11.2	—	
Body diameter Body length Lead wire diameter	φD L φd P	11.0 ~ 11.2 0.5	<u> </u>	
Body diameter Body length Lead wire diameter Body pitch	φD L φd	11.0 ~ 11.2	—	
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead	φD L φd P	11.0 ~ 11.2 0.5 12.7	 ±0.05 ±1.0	Specified by the contact surface between tape & lead
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1	φD L φd P P0	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \end{array} $		tape & lead
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance	φD L φd P P0 P1 P2 F	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \\ 5.1 \\ 6.35 \\ 2.5 \\ \end{array} $	$\begin{array}{c} \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \end{array}$	
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape	φD L φd P P0 P1 P2 F W	$ \begin{array}{r} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \\ 5.1 \\ 6.35 \\ 2.5 \\ 18.0 \\ \end{array} $	$ \begin{array}{c} \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \end{array} $	tape & lead Specified by the contact surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape	φD L φd P P0 P1 P2 F W W0	$ \begin{array}{c} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \\ 5.1 \\ 6.35 \\ 2.5 \\ 18.0 \\ 6.0 \leq \end{array} $	$\begin{array}{c} \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \\ \pm 0.5 \\ \pm 0.5 \\ \pm 0.5 \\ \end{array}$	tape & lead Specified by the contact surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position	φD L φd P P0 P1 P2 F W W0 W1	$ \begin{array}{c} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \\ 5.1 \\ 6.35 \\ 2.5 \\ 18.0 \\ 6.0 \leq \\ 9.0 \\ \end{array} $	$\begin{array}{c} \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \end{array}$	tape & lead Specified by the contact surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping	φD L φd P P0 P1 P2 F W W0	$ \begin{array}{c} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \\ 5.1 \\ 6.35 \\ 2.5 \\ 18.0 \\ 6.0 \leq \end{array} $	$\begin{array}{c} \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \\ \pm 0.5 \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.5 \\ \end{array}$	tape & lead Specified by the contact surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product	φD L φd P P0 P1 P2 F W W0 W1	$ \begin{array}{c} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \\ 5.1 \\ 6.35 \\ 2.5 \\ 18.0 \\ 6.0 \leq \\ 9.0 \\ \end{array} $	$\begin{array}{c} \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \\ \pm 0.5 \\ \pm 0.5 \\ \pm 0.5 \\ \end{array}$	tape & lead Specified by the contact surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping	φD L φd P P0 P1 P2 F W W0 W1 W2	$ \begin{array}{c} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \\ 5.1 \\ 6.35 \\ 2.5 \\ 18.0 \\ 6.0 \leq \\ 9.0 \\ 0 \sim 1.5 \\ \end{array} $	$\begin{array}{c} \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \\ \pm 0.5 \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.75 \end{array}$	tape & lead Specified by the contact surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product from the center	φD L φd P P0 P1 P2 F W W0 W1 W2 H	$ \begin{array}{c} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \\ 5.1 \\ 6.35 \\ 2.5 \\ 18.0 \\ 6.0 \leq \\ 9.0 \\ 0 \sim 1.5 \\ 18.50 \\ 4.0 \\ 1.0 \geq \\ \end{array} $	$\begin{array}{c} \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \\ \pm 0.5 \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.75 \\ -0.50 \end{array}$	tape & lead Specified by the contact surface between tape & lead Specified by the top of an aluminum can
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product from the center Feed hole diameter	φD L φd P P0 P1 P2 F W W0 W1 W2 H φD0	$ \begin{array}{c} 11.0 \sim 11.2 \\ 0.5 \\ 12.7 \\ 12.7 \\ 5.1 \\ 6.35 \\ 2.5 \\ 18.0 \\ 6.0 \leq \\ 9.0 \\ 0 \sim 1.5 \\ 18.50 \\ 4.0 \\ \end{array} $	$\begin{array}{c} \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \\ \pm 0.5 \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.75 \\ -0.50 \end{array}$	tape & lead Specified by the contact surface between tape & lead

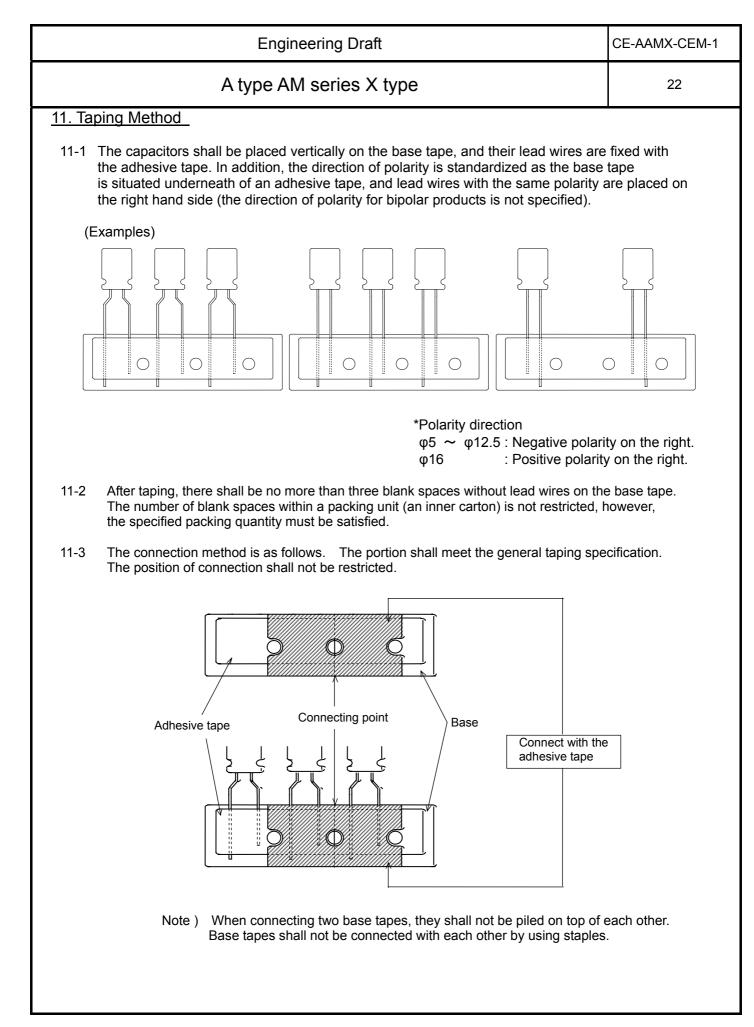
		Engineering Drat	ft			CE-AAMX-CEM
A type AM series X type					19	
10-2. Lead Taping (1) Applicable Range This specification is that taped with sing 2) Taping Shape & D	s applied to p gle tape.				Part Number : B ytic Capacitors (JIS04	4 type)
φ5,φ6.3			φ8			
	P		1 t		P2 P P1 F P0 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
					₩ <u>₩</u> ₩	
lásas	Question	Dimensione		Talawaaaa	, <u>⊧</u> , <u>+</u> ;⊧ <u>_</u>	
Item	Symbol	Dimensions		Tolerance	Rema	
Body diameter	Symbol φD	5 6.3	8	Tolerance ±0.5	Rema	
Body diameter Body length	φD L	5 6.3 11.0 ~ 11.	8 5	±0.5	Rema	
Body diameter Body length Lead wire diameter	φD L φd	5 6.3 11.0 ~ 11. 0.5	8	±0.5 — ±0.05	Rema	
Body diameter Body length Lead wire diameter Body pitch	φD L φd P	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	8 5	±0.5 — ±0.05 ±1.0	Rema	
Body diameter Body length Lead wire diameter	φD L φd	5 6.3 11.0 ~ 11. 0.5	8 5	±0.5 — ±0.05	Rema Specified by the contact tape & lead	; [mm] Irks
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1	φD L φd P P0	$\begin{array}{c c} 5 & 6.3 \\ 11.0 \sim 11.1 \\ 0.5 \\ 12.7 \\ 12.7 \\ 12.7 \end{array}$	8 5	$ \begin{array}{r} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \end{array} $	Specified by the contact tape & lead	 [mm] Irks ct surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance	φD L φd P P0 P1 P2 F	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	8 5	$ \begin{array}{r} \pm 0.5 \\$	Specified by the contact	 [mm] Irks ct surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape	φD L φd P P0 P1 P2 F W	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	8 5	$ \begin{array}{r} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 1.00 \\ \pm 0.8 \end{array} $	Specified by the contact tape & lead Specified by the contact	 [mm] Irks ct surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape	φD L φd P P0 P1 P2 F W W0	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	8 5	$\begin{array}{c} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.8 \\ -0.2 \\ \pm 0.5 \\ \end{array}$	Specified by the contact tape & lead Specified by the contact	 [mm] Irks ct surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position	φD L φd P P0 P1 P2 F W W0 W1	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	8 5	$ \begin{array}{r} \pm 0.5 \\$	Specified by the contact tape & lead Specified by the contact	 [mm] Irks ct surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product	φD L φd P P0 P1 P2 F W W0	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	8 5	$\begin{array}{r} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ + 0.8 \\ -0.2 \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.75 \end{array}$	Specified by the contact tape & lead Specified by the contact	 [mm] Irks ct surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product from the center	φD L φd P P0 P1 P2 F W W0 W1 W2 H	$\begin{array}{c cccc} 5 & 6.3 \\ & 11.0 \sim 11.3 \\ \hline 0.5 \\ & 12.7 \\ \hline 12.7 \\ \hline 3.85 \\ \hline 6.35 \\ \hline 6.35 \\ \hline 5.0 \\ \hline 18.0 \\ \hline 6.0 \leq \\ 9.0 \\ \hline 0 \sim 1.5 \\ \hline 18.5 \\ \hline \end{array}$	8 5 0.6	$\begin{array}{c} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ + 0.8 \\ -0.2 \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.75 \\ -0.50 \end{array}$	Specified by the contact tape & lead Specified by the contact	[mm] Irks ct surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product from the center Lead wire clinch height	φD L φd P P0 P1 P2 F W W0 W1 W2 H H0	$\begin{array}{c ccccc} 5 & 6.3 \\ & 11.0 \sim 11.3 \\ \hline 0.5 \\ & 12.7 \\ \hline 12.7 \\ \hline 3.85 \\ \hline 6.35 \\ \hline 6.35 \\ \hline 5.0 \\ \hline 18.0 \\ \hline 6.0 \leq \\ \hline 9.0 \\ \hline 0 \sim 1.5 \\ \hline 18.5 \\ \hline 16.0 \\ \end{array}$	8 5 0.6	$\begin{array}{r} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ + 0.8 \\ -0.2 \\ \pm 0.5 \\ $	Specified by the contact tape & lead Specified by the contact	[mm] Irks ct surface between
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product from the center Lead wire clinch height Feed hole diameter	φD L φd P P0 P1 P2 F W W0 W1 W2 H H0 φD0	$\begin{array}{c cccc} 5 & 6.3 \\ & 11.0 \sim 11.3 \\ \hline 0.5 \\ & 12.7 \\ \hline 12.7 \\ \hline 3.85 \\ \hline 6.35 \\ \hline 5.0 \\ \hline 18.0 \\ \hline 6.0 \leq \\ \hline 9.0 \\ \hline 0 \sim 1.5 \\ \hline 18.5 \\ \hline 16.0 \\ \hline 4.0 \\ \end{array}$	8 5 0.6	$\begin{array}{c} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ + 0.8 \\ -0.2 \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.75 \\ -0.50 \end{array}$	Specified by the contact tape & lead Specified by the contact tape & lead	[mm]
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product from the center Lead wire clinch height	φD L φd P P0 P1 P2 F W W0 W1 W2 H H0	$\begin{array}{c ccccc} 5 & 6.3 \\ & 11.0 \sim 11.3 \\ \hline 0.5 \\ & 12.7 \\ \hline 12.7 \\ \hline 3.85 \\ \hline 6.35 \\ \hline 6.35 \\ \hline 5.0 \\ \hline 18.0 \\ \hline 6.0 \leq \\ \hline 9.0 \\ \hline 0 \sim 1.5 \\ \hline 18.5 \\ \hline 16.0 \\ \end{array}$	8 5 0.6	$\begin{array}{c} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ + 0.8 \\ -0.2 \\ \pm 0.5 \\ \pm 0.2 \\ \pm 0.2 \\ \end{array}$	Specified by the contact tape & lead Specified by the contact	[mm] Irks

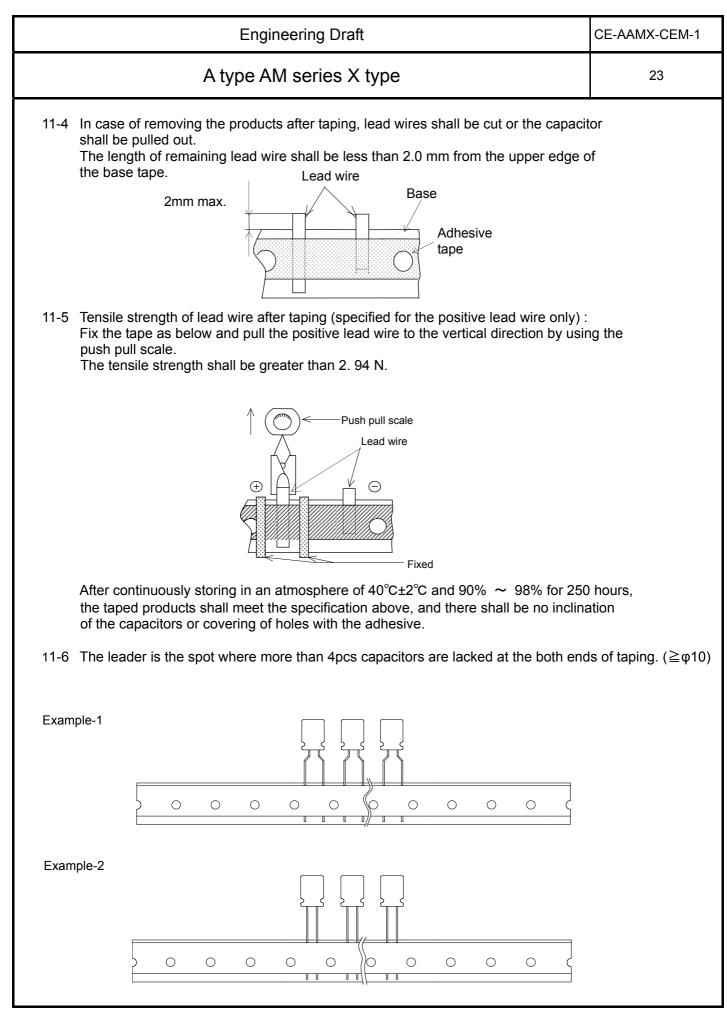
*1 Cumulative deviation of "feed hole pitch" shall be less than 1 mm in 20 sections. *2 Lead forming angle A=90° min

	E	Engineering D	Draft			CE-AAMX-CEM
	A typ	e AM series	s X type			20
10-3. Lead Taping (1) Applicable Range This specification is that taped with sing 2) Taping Shape & Di	s applied to p gle tape.) Part Number : B /tic Capacitors (JIS04	4 type)
W2 W0		P2 P			Δh	
₹		Ρ0 φ	d_ φD0	¥¥ 		
		×			- · ₩ i ↓ ~	[mm]
≤	Symbol	r →l →le Dimens	ions	Tolerance	 i ↓ → Rema	
Item Body diameter	Symbol PD	⊡>I _≯l≰ Dimens 10	ions 12.5		 i ↓ ~+ Rema	
Item Body diameter Body length	φD L	⊡ Dimens 12.5 ~	ions 12.5 25.0	Tolerance	- · · · · · · · · · · · · · · · · · · ·	
Item Body diameter Body length Lead wire diameter	φD L φd	Dimens 10 12.5 ∼ 0.60	ions 12.5 25.0	Tolerance ±0.5 — ±0.05	- · · · · · · · · · · · · · · · · · · ·	
Item Body diameter Body length Lead wire diameter Body pitch	φD L φd P	Dimens 10 12.5 ∼ 0.60 12.7	ions 12.5 25.0) 15.0	Tolerance ±0.5 ±0.05 ±0.05 ±1.0	Rema	
Item Body diameter Body length Lead wire diameter	φD L φd	Dimens 10 12.5 ∼ 0.60	ions 12.5 25.0	Tolerance ±0.5 — ±0.05	Specified by the conta	arks
Item Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1	φD L φd P P0	Dimens 10 12.5 ~ 0.60 12.7 12.7	ions 12.5 25.0) 15.0 15.0	Tolerance ±0.5 ±0.05 ±1.0 ±0.2 ±0.5 ±1.00	Specified by the conta tape & lead	arks ct surface between
Item Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance	φD L φd P P0 P1 P2 F	Dimens Dimens 10 12.5 ~ 0.60 12.7 12.7 3.85 6.35 5.0	ions 12.5 25.0 15.0 15.0 5.00 7.50	Tolerance ± 0.5 ± 0.05 ± 1.0 ± 0.2 ± 0.5 ± 1.00 ± 1.00 ± 0.8 -0.20	Specified by the conta	arks ct surface between
Item Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape	φD L φd P P0 P1 P2 F W	Dimens Dimens 10 12.5 ~ 0.60 12.7 12.7 3.85 6.35 5.0 18.0	ions 12.5 25.0 15.0 15.0 5.00 7.50	Tolerance ±0.5 ±0.05 ±1.0 ±0.2 ±0.5 ±1.00 ±0.8	Specified by the conta tape & lead Specified by the conta	arks ct surface between
Item Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape	φD L φd P P0 P1 P2 F W W0	Dimens 10 12.5 ~ 0.60 12.7 12.7 3.85 6.35 5.0 18.0 6.0 ≦	ions 12.5 25.0 15.0 15.0 5.00 7.50	Tolerance ± 0.5 ± 0.05 ± 1.0 ± 0.5 ± 1.0 ± 0.5 ± 1.00 ± 0.5	Specified by the conta tape & lead Specified by the conta	arks ct surface between
Item Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position	φD L φd P P0 P1 P2 F W W0 W1	Dimens Dimens 10 12.5 ~ 0.60 12.7 12.7 3.85 6.35 6.35 5.0 18.0 6.0 = 9.0	ions 12.5 25.0 15.0 15.0 5.00 7.50	Tolerance ± 0.5 ± 0.05 ± 1.0 ± 0.2 ± 0.5 ± 1.00 ± 1.00 ± 0.8 -0.20	Specified by the conta tape & lead Specified by the conta	arks ct surface between
Item Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape slipping	φD L φd P P0 P1 P2 F W W0	Dimens 10 12.5 ~ 0.60 12.7 12.7 3.85 6.35 5.0 18.0 6.0 ≦	ions 12.5 25.0 15.0 15.0 5.00 7.50	$\begin{array}{c c} \hline Tolerance \\ \pm 0.5 \\ \hline \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \hline \\ \pm 1.00 \\ \pm 0.5 \\ \hline \\ \pm 1.00 \\ \pm 0.5 \\ \hline \\ \pm 0.5 \\ \hline \\ \\ \hline \\ \pm 0.5 \\ \hline \\ \\ \hline \\ \\ \hline \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ $	Specified by the conta tape & lead Specified by the conta	arks ct surface between
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Item Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product from the center	φD L φd P P0 P1 P2 F W W0 W1 W2 H	Dimens 10 12.5 \sim 0.60 12.7 12.7 3.85 6.35 6.35 5.0 18.0 9.0 0 \sim 1 18.5	ions 12.5 25.0 15.0 15.0 5.00 7.50 1.5 0	$\begin{array}{c c} \hline & \\ \hline Tolerance \\ \pm 0.5 \\ \hline \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \hline \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \\ \hline \\ \pm 0.5 \\ \hline \\ \pm 0.5 \\ \hline \\ \hline \\ - \\ \pm 0.5 \\ \hline \\ - \\ \pm 0.5 \\ \hline \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\ -$	Specified by the conta tape & lead Specified by the conta	arks ct surface between
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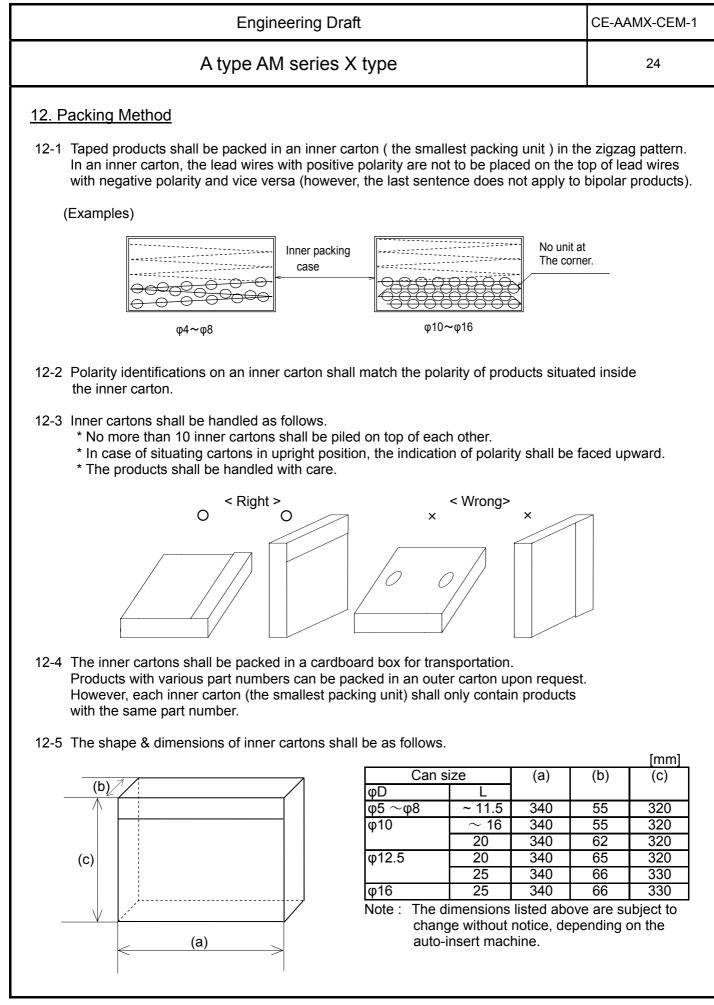
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	A type	AM series X typ	e		21
1) Applicable Range	s applied to pro gle tape.	er φ16) The Suffix of ⊺ oducts, which are Alumin			t type)
		P2 P P P1 F P0 ØD			
					[mm]
Item	Symbol	Dimensions	Tolerance	Rema	
Body diameter	Symbol φD	16	Tolerance	Rema	
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Body diameter Body length Lead wire diameter	φD L φd	16 25.0 0.80	±0.5 — ±0.05	Rema	
Body diameter Body length Lead wire diameter Body pitch	φD L φd P	16 25.0 0.80 30.0	±0.5 — ±0.05 ±1.0	Rema	
Body diameter Body length Lead wire diameter	φD L φd	16 25.0 0.80	±0.5 — ±0.05		irks
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Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape	φD L φd P P0 P1 P2 F W	16 25.0 0.80 30.0 15.0 3.75 7.5 7.5 7.5 18.0	$ \begin{array}{c} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \end{array} $	Specified by the contact tape & lead Specified by the contact	irks
Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape	φD L φd P P0 P1 P2 F W W0	$ \begin{array}{r} 16\\ 25.0\\ 0.80\\ 30.0\\ 15.0\\ 3.75\\ 7.5\\ 7.5\\ 18.0\\ 6.0 \leq \end{array} $	$ \begin{array}{c} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \\ \pm 0.5 \\ \\ \end{array} $	Specified by the contact tape & lead Specified by the contact	irks
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Body diameter Body length Lead wire diameter Body pitch Feed hole pitch *1 Hole center to lead Feed hole center to product center Lead to lead distance Mount tape Adhesive tape Hole position Adhesive tape slipping Height of product from the center Feed hole diameter	φD L φd P P0 P1 P2 F W W0 W1 W2 H φD0	$ \begin{array}{r} 16 \\ 25.0 \\ 0.80 \\ 30.0 \\ 15.0 \\ 3.75 \\ 7.5 \\ 7.5 \\ 7.5 \\ 7.5 \\ 9.0 \\ 0 \sim 1.5 \\ 18.50 \\ 4.0 \\ \end{array} $	$\begin{array}{c} \pm 0.5 \\ \\ \pm 0.05 \\ \pm 1.0 \\ \pm 0.2 \\ \pm 0.5 \\ \pm 0.5 \\ \pm 1.00 \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.5 \\ \\ \pm 0.75 \\ -0.50 \\ \pm 0.2 \end{array}$	Specified by the contact tape & lead Specified by the contact	ct surface betweer

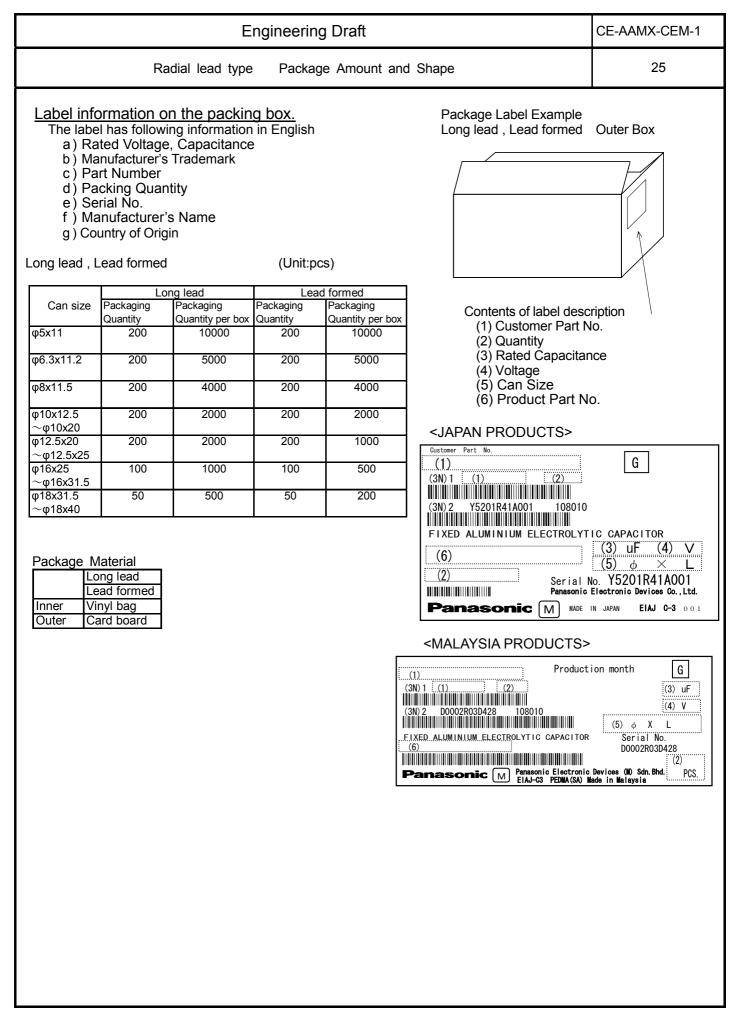
*1 Cumulative deviation of "feed hole pitch" shall be less than 1 mm in 20 sections.



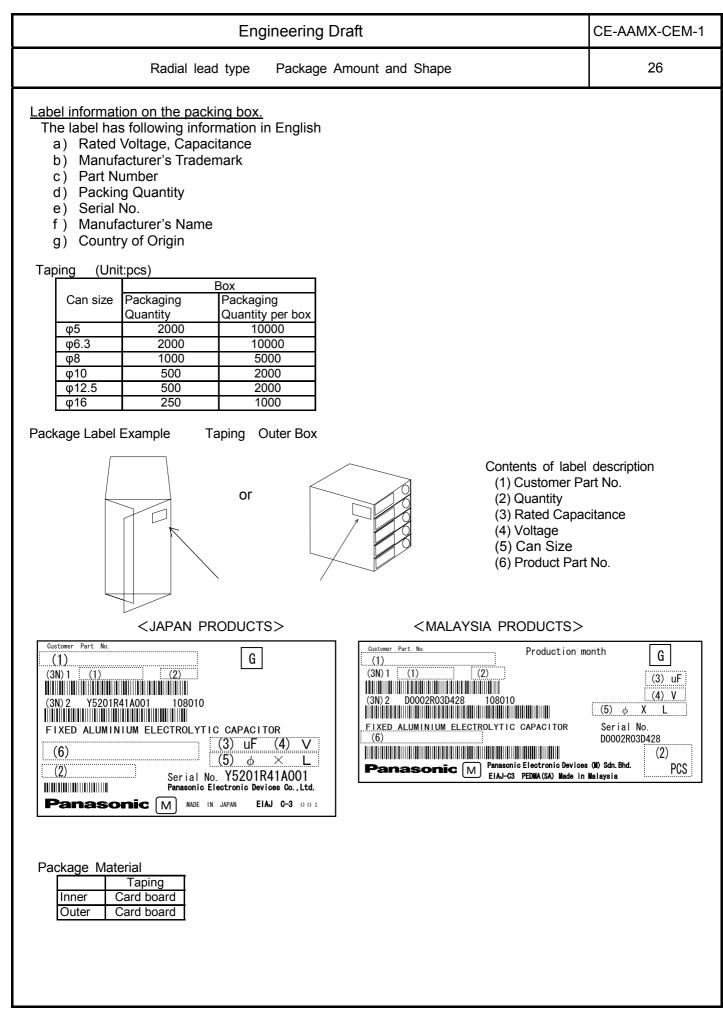


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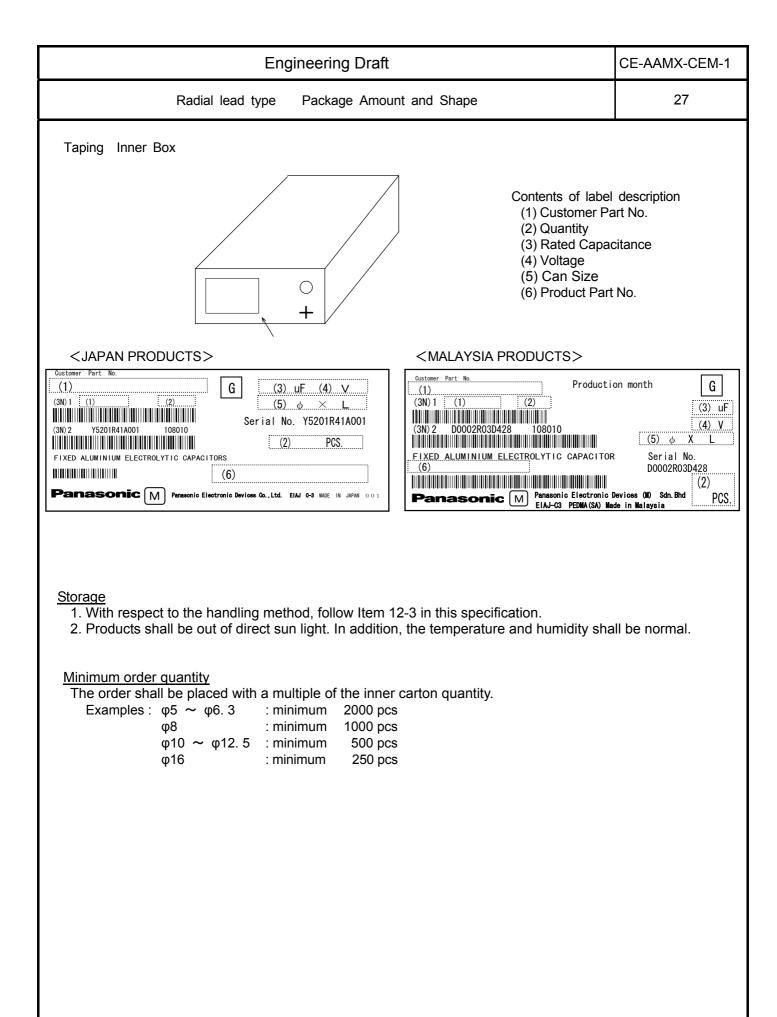




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Application Guidelines

- * This specification guarantees the quality and performance of the product as individual components.
- Before use, check and evaluate their compatibility with installed in your products.
- * Do not use the products beyond the specifications described in this document.
- * Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment where a defect in these products may cause the loss of human life or other signification damage, such as damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment, electric heating appliances, combustion/ gas equipment, rotating equipment, and disaster/crime prevention equipment.
 - The system is equipped with a protection circuit and protection device.
 - The system is equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault.

* Before using the products, carefully check the effects on their quality and performance, and determined whether or not they can be used. These products are designed and manufactured for general-purpose and standard use in general electronic equipment.

These products are not intended for use in the following special conditions.

- 1. In liquid, such as Water, Oil, Chemicals, or Organic solvent
- 2. In direct sunlight, outdoors, or in dust
- 3. In vapor, such as dew condensation water of resistive element, or water leakage, salty air, or air with a high concentration corrosive gas, such as Cl2, H2S, NH3, SO2, or NO2
- 4. In an environment where strong static electricity or electromagnetic waves exist
- 5. Mounting or placing heat-generating components or inflammables, such as vinyl-coated wires, near these products
- 6. Sealing or coating of these products or a printed circuit board on which these products are mounted, with resin and other material
- 7. Using resolvent, water or water-soluble cleaner for flux cleaning agent after soldering.
 - (In particular, when using water or a water-soluble cleaning agent, be careful not to leave water residues)
- * Please arrange circuit design for preventing impulse or transitional voltage.

Do not apply voltage, which exceeds the full rated voltage when the capacitors receive impulse voltage, instantaneous high voltage, high pulse voltage etc.

* Electrolyte is used in the products. Therefore, misuse can result in rapid deterioration of characteristics and functions of each product. Electrolyte leakage damages printed circuit and affects performance, characteristics, and functions of customer system.

1. Circuit Design

1.1 Operating Temperature and Frequency

Electrical parameters for electrolytic capacitors are normally specified at 20 °C temperature and 120 Hz frequency.

These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration. (1) Effects of operating temperature on electrical parameters

- a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
- b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
 - a) At higher frequencies, capacitance and impedance decrease while $tan\delta$ increases.
- b) At lower frequencies, heat generated by ripple current will rise due to an increase in equivalent series resistance (ESR).

1.2 Operating Temperature and Life Expectancy

- (1) Expected life is affected by operating temperature. Generally, each 10 °C reduction in temperature will double the expected life. Use capacitors at the lowest possible temperature below the upper category temperature.
- (2) If operating temperatures exceed the upper category limit, rapid deterioration of electrical parameter will occur and irreversible damage will result.

Check for the maximum capacitor operating temperatures including ambient temperature, internal capacitor temperature rise due to ripple current, and the effects of radiated heat from power transistors, IC's or resistors.

Avoid placing components, which could conduct heat to the capacitor from the back side of the circuit board.

(3) The formula for calculating expected life at lower operating temperatures is as follows ;

$$L_2 = L_1 x 2^{\frac{T_1 - T_1}{10}}$$

- L_1 : Guaranteed life (h) at temperature, $T_1 °C$
- L_2 : Expected life (h) at temperature, $T_2 °C$
- T_1 : Upper category temperature (°C)
- T₂ : Actual operating temperature, ambient temperature + temperature rise due to ripple current heating(°C)

(4) Please use according to the lifetime as noted in this specification. Using products beyond end of the lifetime may change characteristics rapidly, short-circuit, operate pressure relief vent, or leak electrolyte.

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 1.3 Common Application Conditions to Avoid The following misapplication load conditions will cause rapid deterioration of a capacitor's electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur, causing the pressure relief vent to operative of electrolyte. Under extreme conditions, explosion and fire ignition could result. The leaked electrolyte is combustible and electrically conductive. (1) Reverse Voltage Output Description: Description:<td>ate and resultant leakage</td>	ate and resultant leakage
 (1) Revelocion to large of the polarity. Verify correct polarity before insertion. For circuits with changing or uncertain policapacitors. DC bipolar capacitors are not suitable for use in AC circuits. (2) Charge / Discharge Applications Standard capacitors are not suitable for use in repeating charge/discharge applications. For charge/ discharge 	
with your actual application condition. (3) Over voltage Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating short periods of time.	are acceptable for
 Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage (4) Ripple Current Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a high ripple currents. In addition, consult us if the applied ripple current is to be higher than the maximum specified solution. Ensure that rated ripple currents that superimposed on low DC bias voltages do not cause reverse voltage condition. 1.4 Using Two or More Capacitors in Series or Parallel 	a capacitor designed for ied value.
 (1) Capacitors Connected in Parallel The circuit resistance can closely approximate the series resistance of the capacitor, causing an imbalance of rip the capacitors. Careful wiring methods can minimize the possible application of an excessive ripple current to a (2) Capacitors Connected in Series 	
Differences in normal DC leakage current among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage currents can prevent capacitor voltage in 1.5 Capacitor Mounting Considerations	nbalances.
 (1) Double-Sided Circuit Boards Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board. When dipping into an excess solder may deposit under the capacitor by capillary action, causing short circuit between anode and c (2) Circuit Board Hole Positioning 	
The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole into the subsequently pro Special care when locating hole positions in proximity to capacitors is recommended.(3) Circuit Board Hole Spacing	
The spacing of circuit board holes should match the lead wire spacing of capacitors within the specified tolerance Incorrect spacing can cause an excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to the short or open circuit, increased leakage current, or elect (1) Chapter for Case Manuted Process	
(4) Clearance for Case Mounted Pressure Relief Capacitors with case mounted pressure relief require sufficient clearance to allow proper pressure relief operatio The minimum clearances are dependent of capacitor diameters as follows. Dia. 6. 3 mm ~Dia. 16 mm : 2 mm minimum, Dia. 18 mm ~Dia. 35 mm : 3 mm minimum, Dia 40 mm or great	
 (5) Clearance for Seal Mounted Pressure Relief Provide a hole on a circuit board to relieve gas when a pressure relief of a capacitor is situated underneath of the (6) Wiring Near the Pressure Relief 	
Avoid locating high voltage, high current wiring, or circuit board paths above the pressure relief . Flammable, high temperature gas that exceeds 100 °C may be released and could dissolve the wire insulation at (7) Circuit Board Patterns Under the Capacitor	nd ignite.
Avoid circuit board runs underneath the capacitor, as an electrical short can occur due to an electrolyte leakage. (8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downward. Tighten the terminal and mounting bracket ecrowy within the terminal side of the capacition facing downward.	
Tighten the terminal and mounting bracket screws within the torque range specified in the specification. 1.6 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows. (1) Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other	circuit naths
 (1) Detween the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit pat (2) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit pat 1.7 Capacitor Sleeve The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrical 	ths.
The sleeve may split or crack if immersed into solvents such as toluene or xylene and then subsequently exposed to	•

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 2. Capacitor Handling Techniques 2.1 Considerations Before Using Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment. Transient recovery voltage may be generated in the capacitor due to dielectric absorption. f required, this voltage can be discharged with a resistor with a value of about 1kΩ. Capacitors stored for a long period of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately 1kΩ. If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors. Dented or crushed capacitors should not be used. The seal integrity can be damaged and loss of electrolyte/shor 2. Capacitor Insertion Verify the correct polarity of the capacitor before insertion. Verify the correct polarity of the capacitor before insertion. Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals. Ensure that the lead clinching operation done by auto insertion equipments does not stress the capacitor leads whit the capacitor. Manual Soldering Apply soldering conditions (temperature and time) based on the specification, or do not exceed temperature of 350 seconds or less. If lead wires must be modified to meet terminal board hole spacing, avoid stress on the lead wire where it enters th for a soldering Baoldering Do not immerse the capacitor body into the solder bath as excessive internal pressure could result. Avoid physical contacts between the tip of the soldering iron and capacitors to prevent melting of the vinyl sleeve. 	tened life can result. ere they enter the seal of tion. °C for 3
 (3) Do not allow other parts or components to touch the capacitor during soldering. 2.5 Other Soldering Considerations Rapid temperature rise during the preheat operation and resin bonding operation can cause cracking of the capacitor For heat curing, do not exceed 150 °C for the maximum time of 2 minutes. 2.6 Capacitor Handling after Soldering (1) Avoid moving the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal. (2) Do not use the capacitor after assembly to prevent failure due to excessive shock. 2.7 Circuit Board Cleaning (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up to 5 minutes and up to 60 °C maximum temperatures. The boards should be thoroughly rinsed and dried. The use of ozone depleting cleaning agents is not recommended for the purpose of protecting our environment. (2) Avoid using the following solvent groups unless specifically allowed in the specification ; Halogenated cleaning solvents : except for solvent resistant capacitor types, halogenated solvents can permeate internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time require specification. 1-1-1 trichloroethane should never be used on any aluminum elect 	e the seal and cause ements based on the
 Alkaline solvents : could react and dissolve the aluminum case. Petroleum based solvents : deterioration of the rubber seal could result. Xylene : deterioration of the rubber seal could result. Acetone : removal of the ink markings on the vinyl sleeve could result. (3) A thorough drying after cleaning is required to remove residual cleaning solvents that may be trapped between the oboard. Avoid drying temperatures, which exceed the Upper category temperature of the capacitor. (4) Monitor the contamination levels of the cleaning solvents during use in terms of electrical conductivity, pH, specific g Chlorine levels can rise with contamination and adversely affect the performance of the capacitor. (5) Depending on the cleaning method, the marking on a capacitor may be erased or blurred. 	
 (5) Depending on the cleaning method, the marking on a capacitor may be clased or blurred. Please consult us if you are not certain about acceptable cleaning solvents or cleaning methods. 2.8 Mounting Adhesives and Coating Agents When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated s Also, avoid the use of chloroprene based polymers. Harden on dry adhesive or coating agents well lest the solvent should be left. 	solvents.
 After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capaboard. 2.9 Funigation In exporting electronic appliances with aluminum electrolytic capacitors, in some cases fumigation treatment usir compound as methyl bromide is conducted for wooden boxes. If such boxes are not dried well, the halogen left in the box is dispersed while transported and enters in the capacitors. Therefore, after performing fumigation and drying matis left	ng such halogen apacitors inside.

is left. Don't perform fumigation treatment to the whole electronic appliances packed in a box.

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 3. Precautions for using capacitors 3.1 Environmental Conditions Capacitors should not be stored or used in the following environments. (1) Exposure to temperatures above the upper category or below the lower category temperature of the capacit (2) Direct contact with water, salt water, or oil. (3) High humidity conditions where water could condense on the capacitor. (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, Chlorine compound, Br ammonia. (5) Exposure to ozone, radiation, or ultraviolet rays. (6) Vibration and shock conditions exceeding specified requirements. 3.22 Electrical Precautions (1) Avoid touching the terminals of a capacitor as a possible electric shock tould result. The exposed alumint could also cause electric shock if touched. (2) Avoid short circuiting the area between the capacitor terminals with conductive materials including liquids s 4. Energency Procedures (1) If the pressure relied of the capacitor operates, immediately turn off the equipment and disconnect from the This will minimize an additional damage caused by the vaporizing electrolyte. (2) Avoid contact with the escaping electrolyte gas, which can exceed 100 °C temperatures. If electrolyte or gas is ingested by mouth, gargle with water. If electrolyte or gas enters the eye, immediately fush the eye with large amounts of water. If electrolyte or agas ingested by mouth, gargle with water. If electrolyte or agas ingested by mouth, gargle with required to restore the oxide film. This surge current out capacitor increases with long storage times. The aluminum oxide film deteriorates as a fused without reconditioning, an abnormally high current will be required to restore the oxide film. This surge current out capacitor increases with long storage times. 1. Environmental Conditions 1. Environmental Conditions 1. E	omine, Bromine compound or um case is not insulated and uch as acids or alkaline solutions. power source. function of temperature and time. litioned by applying the rated or. omine, Bromine compound or